

MULTI-INNO TECHNOLOGY CO., LTD.

LCD MODULE SPECIFICATION

Model : MI9664GK

Revision	
Engineering	
Date	
Our Reference	



REVISION RECORD

Date	Rev.No.	Revision Items	Prepared	Checked	Approved
2007.10.15	V1.0	NEW			



CONTENTS

1. General Specifications	-1
2. Outline Drawing	-2
3. Circuit Block Diagram	-3
4. Absolute Maximum Ratings	4
5. Electrical Specifications and Instruction Code	-5
6. Optical Characteristics	12
7. Reliability	16
8. Quality level	17
9. Precautions for Use of LCD Modules	21



1.General Specifications

Item	Contents	Unit	Note
LCD Type	CSTN	-	
Display color	56K/260K		1
LCD Duty	1/70	-	
LCD Bias	1/9	-	
Viewing Direction	6:00	O'Clock	
Viewing Area(W×H)	-	mm	
Active Area(W×H)	20.1×13.4	mm	
Number of Dots	96 (RGB)×64	mm	
Dote Size(W×H)	-	mm	
Dot Pitch(W×H)	-	mm	
Controller	ST7628	-	
V _{DD}	2.8	V	
IOVcc	2.8	V	
Outline Dimensions	Refer to outline drawing on next page		
Backlight	LED(white)	-	
Operating Temperature	-20∼+70°C	-	
Storage Temperature	-30∼+80°C	-	
Weight	TBD	g	2
Data Transfer	8 bits parallel	-	
Polarizer Mode	Transmissive/Positive	-	

Note 1: Color tune is slightly changed by temperature and driving voltage.

Note 2: TBD- To Be Determined.

Note: Requirements on Environmental Protection:RoHS



2. Outline Drawing





3. Circuit Block Diagram





Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	V_{DD}	-0.3	3.3	V	
Power Supply Voltage for Logic	IOVcc	-0.3	3.3	V	
Logic Signal Input Voltage	V_{I}	-0.3	V _{DD} +0.3	V	
Operating Temperature	Тор	-20	+70	°C	
Storage Temperature	Tst	-30	+80	°C	

4. Absolute Maximum Ratings(Ta=25°C)

Notes:

- 1. If the module is above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
- 2. $V_{DD} > V_{SS}$ must be maintained.



5. Electrical Specifications and Instruction Code

5.1 Electrical characteristics (Ta=25°C)

Param	eter	Symbol	Condition	Min	Тур	Max	Uni t	Note
Operation voltage		V _{OP}	Ta=25℃	-	9.5	-	V	1
Input	'H'	V_{IH}	V _{DD} =2.8V	$0.8V_{DD}$	-	V_{DD}	V	
voltage	ʻL'	V _{IL}	V _{DD} =2.8V	Vss	-	$0.2V_{DD}$	V	
Output	'H'	V _{OH}	-	$0.8V_{DD}$	-	V_{DD}	V	
Voltage	ʻL'	V _{OL}	-	Vss	-	$0.2V_{\text{DD}}$	V	
Curre	ent	I _{CC1}	Normal mode	-	70	85	mA	2
Consum	ption	I _{CC2}	Stand-by mode	-	-	-	mA	3

Note:

- 1: IC default setting, Duty:1/70
- 2: Display full white. Backlight on state.
- 3: IC on standby mode.



5.2 LED backlight specification

Ite	em	Symbol	Condition	Min	Тур	Max	Unit	Note
Forward	l voltage	V_{f}	I _f =15mA		3.2		V	
Reverse	voltage	Vr				4	V	
Forward	Normal	I _{pn}	1 shin		15	20		
current	Dimming	I _{pd}	1-cmp		15	20	IIIA	
Reverse Current		Ir	V _r =4V			15	μΑ	
Unifo	ormity		I _f =15mA	80%				



5.3 Interface Signals

Pin No.	Symbol	I/O	Function
1	LED_K	Р	Backlight LED-
2	LED_A	Р	Backlight LED+
3	A0	Ι	Reg selection for COM/DATA
4	RW_WR	Ι	Read/Write control input pin
5	D0	I/O	
6	D1	I/O	
7	D2	I/O	
8	D3	I/O	
9	D4	I/O	8bit data bus for LCD
10	D5	I/O	
11	D6	I/O	
12	D7	I/O	
13	E_RD	Ι	Read/Write execution control pin
14	RST	Ι	Reset input pin When RSTB='L', initialization is executed
15	IF1	Ι	
16	IF2	Ι	Parallel/Serial data input select input
17	IF3	Ι	
18	/CS	Р	Main LCD Chip select input pin
19	VDDI	Р	Power supply for logic circuit
20	VSS	Р	Ground for logic circuit
21	VM	Р	Vm is the I/O pin of LCD bias supply voltage
22	VDDA	Р	Power supply for LCD.
23	VLCD	Р	LCD Driving Voltage
24	XV00UT	Р	Positive LCD driver supply voltages
25	XGOUT	Р	Negative LCD driver supply voltages.



5.4 Interface Timing Chart

Note: Please refer to SITRONIX'S data sheet for more details.





Figure 7.1 Parallel Data Transfer Example Chart



5.5 Function Description

Com	Command Table-1 , /EXT= H , L, or floating													
Hex	Command	AO	/RD	/WR	D7	D6	D5	D4	D3	D2	D1	DO	Function	Ref.
(00h)	NOP	0	1	0	0	0	0	0	0	0	0	0	No Operation	8.1.1
(01h)	SWRESET	0	1	0	0	0	0	0	0	0	0	1	Software reset	9.1.2
(04h)	RODID	0	1	0	0	0	0	0	0	1	0	0	Read Display ID	9.1.3
		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
•		1	0	1	ID17	ID18	ID15	ID14	ID13	ID12	ID11	ID10	ID1 read (D23-D16)	
-		1	0	1	1	ID28	ID25	ID24	ID23	ID22	ID21	ID20	ID2 read (D15-D8)	
•		1	0	1	ID37	ID38	ID35	ID34	ID33	ID32	ID31	ID30	ID3 read (D7-D0)	
(09h)	RODST	0	1	0	0	0	0	0	1	0	0	1	Read Display Status	8.1.4
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
		1	0	1	ST31	ST 30	ST29	ST 28	ST 27	ST26	ST25	ST24	(D31-D24)	
•		1	0	1	ST23	ST 22	ST21	ST 20	ST 19	ST18	ST17	ST 16	(D23-D16)	
•		1	0	1	ST15	ST 14	ST13	ST 12	ST 11	ST10	ST9	STS	(D15-D8)	
•		1	0	1	ST7	ST6	ST5	ST4	ST3	ST2	ST1	STO	(07-00)	
(0Ah)	ROOPM	0	1	0	0	0	0	0	1	0	1	0	Read Display Power Mode	9.1.5
•		1	0	1	•	•	•	•	•	•	•		Dummy read	
-		1	0	1	D7	D6	D5	D4	D3	D2	0	0	•	
(0Bh)	RODMADCTR	0	1	0	0	0	0	0	1	0	1	1	Read Display MADCTR	9.1.6
•		1	0	1	•	•	•	•	•	•	•		Dummy read	
		1	0	1	D7	D6	D5	D4	D3	0	0	0	•	
(0Ch)	RODCOLMOD	0	1	0	0	0	0	0	1	1	0	0	Read Display Pixel Format	9.1.7
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
-		1	0	1	0	0	0	0	0	02	D1	DO	•	
(ODh)	ROOM	0	1	0	0	0	0	0	1	1	0	1	Read Display Image Mode	9.1.8
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
		1	0	1	D7	0	D5	D4	D3	0	0	0	-	
(0Eh)	RDDSM	0	1	0	0	0	0	0	1	1	1	0	Read Display Signal Mode	9.1.9
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
-		1	0	1	D7	D6	0	0	0	0	0	0	-	
(OFh)	RDDSDR	0	1	0	0	0	0	0	1	1	1	1	Read Display Self-diagnostic result	9.1.10
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
		1	0	1	D7	D6	D5	D4	0	0	0	0	•	



Ver	1.0
V CI	1.0

(10h)	SLPIN	0	1	0	0	0	0	1	0	0	0	0	Sleep in & booster off	9.1.11
(11h)	SLPOUT	0	1	0	0	0	0	1	0	0	0	1	Sleep out & booster on	9.1.12
(12h)	PTLON	0	1	0	0	0	0	1	0	0	1	0	Partial mode on	9.1.13
(13h)	NORON	0	1	0	0	0	0	1	0	0	1	1	Partial off (Normal)	9.1.14
(20h)	INVOFF	0	1	0	0	0	1	0	0	0	0	0	Display inversion off (normal)	9.1.15
(21h)	INVON	0	1	0	0	0	1	0	0	0	0	1	Display inversion on	9.1.16
(22h)	APOFF	0	1	0	0	0	1	0	0	0	1	0	Ali pixel off (Only for test purpase)	9.1.17
(23h)	APON	0	1	0	0	0	1	0	0	0	1	1	All pixel on (Only for test purpose)	9.1.18
(25h)	WRONTR	0	1	0	0	0	1	0	0	1	0	1	Write contrast	9.1.19
•		1	1	0	0	EV6	EV5	EV4	EV3	EV2	EV1	EV0	EV = 0 to 127	
(28h)	DISPOFF	0	1	0	0	0	1	0	1	0	0	0	Display off	9.1.20
(29h)	DISPON	0	1	0	0	0	1	0	1	0	0	1	Display on	9.1.21
(2Ah)	CASET	0	1	0	0	0	1	0	1	0	1	0	Column address set	9.1.22
		1	1	0	0	XS6	X85	X84	X83	X82	XS1	XSO	X_ADR start: 0≦ XS ≦61h	
		1	1	0	0	XE6	XE5	XE4	XE3	XE2	XE1	XEO	X_ADR end: XS≦XE ≦61h	
(2Bh)	RASET	0	1	0	0	0	1	0	1	0	1	1	Row address set	9.1.23
		1	1	0	0	Y86	Y85	Y84	Y83	Y82	Y81	YSO	Y_ADR start: 0≦ YS ≦45h	
		1	1	0	0	YE6	YE5	YE4	YE3	YE2	YE1	YEO	Y_ADR end: YS≤YE≤45h	
(2Ch)	RAMWR	0	1	0	0	0	1	0	1	1	0	0	Memory write	9.1.24
		1	1	0	D7	D6	D5	D4	03	D2	D1	00	Write data	
(2Dh)	RGBSET	0	1	0	0	0	1	0	1	1	0	1	Colorset for 256 or 4k color display	9.1.25
-		1	1	0	-	•	R5	R4	R3	R2	R1	RO	R ed tone (00000)	
-		1	1	0	1	1	1	1	1	1	:	5	-	
-		1	1	0	•	•	R5	R4	R3	R2	R1	RO	Red tone (11111)	
-		1	1	0	•	•	G5	G4	8	G2	G1	GO	Green tone (000000)	
		1	1	0	1	1	1	1	1	1	1	5	-	
		1	1	0	-	•	G5	G4	G3	G2	G1	GO	Green tone (111111)	
		1	1	0	-	•	85	B4	83	82	81	BO	Bluetone (00 000)	
		1	1	0	1	1	1	:	1	1	:	1	-	
		1	1	0	-	•	85	84	83	82	81	BO	Bluetone (11 111)	
(30h)	PTLAR	0	1	0	0	0	1	1	0	0	0	0	Partial start/end address set	9.1.26
		1	1	0	0	P\$6	P85	P84	P\$3	F\$2	PS1	PSO	Start address (0-69)	
-		1	1	0	0	PE6	PE5	PE4	PE3	PE2	RE1	PEO	End address (0~69)	



V	er	1	.0	

(33h)	SCRLAR	0	1	0	0	0	1	1	0	0	1	1	Scroll Area	9.1.27
-		1	1	0	0	TFA6	TF A5	TFA4	TFA3	TFA2	TFA1	TFAD	TFA= 0-70	
-		1	1	0	0	VSA6	V\$A5	VSA4	VSA3	VSA2	V\$A1	VSA0	VSA= 0-70	
-		1	1	0	0	BFA6	BF A5	BFA4	BFA3	BFA2	BFA1	BFA0	BFA= 0-70	
(34h)	TEOFF	0	1	0	0	0	1	1	0	1	0	0	Tearing effectline off	9.1.28
(35h)	TEON	0	1	0	0	0	1	1	0	1	0	1	Tearing effect mode set & on	9.1.29
-		1	1	0	•	•	•	•	•	•	•	м	"0": mode1, "1": mode2	
(36h)	MADCTR	0	1	0	0	0	1	1	0	1	1	0	Memory data access control	9.1.30
-		1	1	0	MY	MX	MV	ML	RGB	•	•		•	
(37h)	VSCSAD	0	1	0	0	0	1	1	0	1	1	1	Scroll start address of RAM	9.1.31
		1	1	0	0	SSA6	SSA5	SSA4	SSA3	88A2	SSA1	SSA0	SSA = 0-69	
(38h)	IDMOFF	0	1	0	0	0	1	1	1	0	0	0	Idle mode off	9.1.32
(39h)	IDMON	0	1	0	0	0	1	1	1	0	0	1	Idle mode on	9.1.33
(3Ah)	COLMOD	0	1	0	0	0	1	1	1	0	1	0	Interface pixel format	9.1.34
-		1	1	0	•	•	•		•	P2	P1	PO	Interface format	
(DAh)	RDID1	0	1	0	1	1	0	1	1	0	1	0	Read ID1	9.1.35
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
-		1	0	1	ID17	ID16	ID15	ID14	ID13	ID12	ID11	ID10	(07-00)	
(DBh)	R DID2	0	1	0	1	1	0	1	1	0	1	1	Read ID2	9.1.38
-		1	0	1	•	•	•	•	•	•	•	•	Dummy read	
-		1	0	1	ID27	ID28	ID25	ID24	ID23	ID22	ID21	ID20	(07-00)	
(DCh)	R DID3	0	1	0	1	1	0	1	1	1	0	0	Read ID3	9.1.37
-		1	0	1	•	•	•		•	•	•	•	Dummy read	
-		1	0	1	ID37	ID36	ID35	ID34	ID33	ID32	ID31	ID30	(07-00)	

Note 1: When /EXT connects to H or floating, commands which are not defined in "Command Table-1" are treated as NOP (00H)

command.

Note 2 Commands 10H, 12H, 13H, 20H, 21H, 25H, 28H, 29H, 30H, 36H (Bit ML only), 38H and 39H are updated during V-sync when

Module is in Sleep Out Mode to avoid ab normal visual effects.

During Sleep In mode, these commands are updated immediately.

Read status (09H), Read Display Power Mode (0AH), Read Display MADCTR (0BH), Read Display Pixel Format (0CH), Read Display Image Mode (0DH), Read Display Signal Mode (0EH) and Read Display Self Diagnostic Result (0FH) of these commands is updated Immediate ly both In Sleep In mode and Sleep Out mode.



6. Optical Characteristics

Item	Sy	ymbol	Condition	Min.	Тур.	Max.	Unit	Note
Brightness		Вр	Ф1=0°	140	-	-	Cd/m ²	1
Uniformity	2	∆Bp	Ф2=0°	70			%	1,2
Viewing	$\Phi_1(u)$	p down)	Cr>10		TBD		Deg	2
Angle	$\Phi_2(le$	eft right)	CI≥I0		TBD			3
Contrast Ratio		Cr	Ф0°	150	300	-	-	4
Response	Tr		$\Phi_1=0^{\circ}$ $\Phi_2=0^{\circ}$	-	20	40	ms	5
Time	T _f			-	15	30		5
	W X y	Х		TBD	-	TBD	-	
		у		TBD	-	TBD	-	
	р	х		TBD	-	TBD	-	
Color of	К	у		TBD	-	TBD	-	
Coordinate	G	Х	$\Phi_1=0^\circ$ $\Phi_2=0^\circ$	TBD	-	TBD	-	1,6
		у	¥2 0	TBD	-	TBD	-	
	В	X		TBD	-	TBD	-	
		у		TBD	-	TBD	-	
NTSC Ratio	S				TBD			

NOTE: TBD is to be determined



Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment PR-705 (Φ10mm)



Note 2: $\triangle Bp = Bp (Min.) / Bp (Max.) \times 100 (\%)$ Bp (Max.) = Maximum brightness in 9 measured spots

Bp (Min.) = Minimum brightness in 9 measured spots.



Measurement equipment PR-705 (Φ10mm)

Note 3: Definition of Viewing Angle(Test LCD using DMS501)







Note 4: Definition of contrast ratio.(Test LCD using DMS501)

Contrast ratio(Cr) = $\frac{Brightness of selected dots}{Brightness of non-selected dots}$

Note 5: Definition of Response time(Test LCD using DMS501)











Color gamut:

 $S = \frac{area \ of \ RGB \ triangle}{area \ of \ NTSC \ triangle} \times 100\%$



7. Reliability

_

No.	Test Item	Test condition	Criterion
1	High Temperature	80℃±2℃96H	
1	Storage	Restore 4H at 25℃	
2	Low Temperature	-30℃±2℃ 96H	
2	Storage	Restore 4H at 25℃	
2	High Temperature	70℃±2℃ 48H	
5	Operation	Restore 4H at 25°C	
4	Low Temperature	-20℃±2℃ 48H	1 After testing cosmetic
4	Operation	Restore 4H at 25°C	defects should not hannen
5	High Temperature	40℃±2℃ 90%RH	2 Total current consumption
5	/Humidity Storage	48H	should not be over 10% of
6	Temperature Cycle	-30°C ↔ 25°C ↔ 80°C 5min 30min ↔ 25°C , 5min after 10cycle, Restore 4H at 25°C	initial value.
7	Vibration Test	10Hz~150Hz, 100m/s2,	
/	(package state)	120min	
	Shock Test	Half- sine wave,	Not allowed cosmetic and
8	(nackage state)	300m/s2,	electrical defects
	(Puenuge State)	18ms	
9	Atmospheric	25kPa 16H	
	Pressure Test	Restore 2H	



8 Quality level

8.1 Notes for quality standard

	Note							
General	1. Should any defects which are not specified in this standard happen, additional							
	standard shall be determined by mutual agreement between customer and							
	Multi-inno.							
	2. Viewing Area should be the area which Multi-inno guarantees.							
	3. Limited sample should be prior to this Inspection standard.							
	4. Viewing Judgement should be under static pattern.							
	5. Inspection conditions							
	Temperature $25\pm5^{\circ}$							
	Inspection angle : 45degrees in I CD view dir	ection						
Definitions of	Pinhole Bright spot The color of a small area	is different from the						
Inspection	Black spot White spot remainder	is anterent from the						
items	Black line. White Line. The phenomenon dose not chan	ge with voltage.						
	Foreign particle, Bubble	8 8 8-						
	Contrast variation The color of a small area	is different from the						
	remainder.	is unificient from the						
	The phenomenon changes with	voltage.						
	Polarizer defect Scratch, Dirt, Particle, Bubble on polarizer or l							
	polarizer and glass.	_						
	Glass defect Glass crack, Shaved corner of glass, Surplus glass							
Definitions of	X1 X2							
Inspection	$ \rightarrow \leftarrow \rightarrow \leftarrow$ Dividing A zone and	B zone proceed to make						
ranges								
	H =							
	\land A zone : Inside Viewing area							
	B zone : Outside View	ing area						
	$\begin{bmatrix} 1 \\ 1 \end{bmatrix} = \begin{bmatrix} 1 \\ 1 \end{bmatrix} = \begin{bmatrix} XI(A, A \sim V, A) \end{bmatrix} = \begin{bmatrix} mm \\ N2(A, A, V, A) \end{bmatrix} = \begin{bmatrix} mm \\ mm \end{bmatrix}$							
	$1 \downarrow \downarrow \downarrow \downarrow Y1$ $X2(A, A \sim V, A)$. mm							
	$\uparrow \qquad \qquad$							
Outgoing	Inspection level II Normal Inspection Sampling standard	conforms to GB2828						
Inspection	Rank Inspection Item	AOL (Number						
standard	1	of defective						
		I CMs counted)						
	Major All Experience defects (Such as No display, Disp	LUNIS counted)						
	defect abnormally Open or missing segment Sh	lay 0.03						
	circuit Missing component No sound Bli	abnormally, Open or missing segment, Short						
	abnormally) Outline dimension beyond	the						
	drawing							
	Minor Appearance defects, such as Black/White sp	oot, 1.50						
	defect Bright spot, Pinhole, Black/White line, Contr	ast						
	variation, Bubble Glass defect, Polarizer defe	ect,						
	and so on. Details of the standard as follows.							



8.2Standards of inspection items

		Judgement standard				
Inspection item		Category		Acceptable number		
				A zone	B zone	
1	Black spot, White spot Bright Spot, Pinhole Foreign P Bubble and Particle Between polarizer Scratch on polarizer	Particle, $\Phi = (a+b)/2(mm)$ the and glass, $e^{-(a+b)/2(mm)}$	A B C D	$\Phi \leq 0.15$ $0.15 < \Phi \leq 0.20$ $0.20 < \Phi \leq 0.30$ $0.30 < \Phi$ Total defective point(B,C)	Neglecte 2 1 0 3	Neglected
2	Black line, White line, Bubble and Particle Between Polarizer and glass, Scratch on polarizer	W:Width, L:Length(mm)	A B C D	$W \le 0.10$ 0.01 <w 0.03="" 3.0<br="" l="" ≤="">0.03<w 0.05="" 3.0<br="" l="" ≤="">0.05<w Total defective point(B,C)</w </w></w>	Neglected 2 1 0 2	Neglected
3	Contrast variation	$ \begin{array}{c} b \\ \hline a \\ \Phi = (a+b)/2(mm) \end{array} $	A B C D	$\Phi \leq 0.2$ $0.2 < \Phi \leq 0.3$ $0.3 < \Phi \leq 0.4$ $0.4 < \Phi$ Total defective point(B,C)	Neglected 2 1 0 3	Neglected
4	Bubble inside cell		any	size	none	none
5	Polarizer defect (if Polarizer is used)	Scratch and damage on polarizer, Particle on polarizer or between polarizer and glass. Bubble, dent and	Ref	ter to item 1 and item 2. $\Phi \leq 0.3$	Neglected	Neglected
		convex	B	$0.3 < \Phi \le 0.7$	2	
			<u>C</u>	<u>0.7<Φ</u>	0	
6	Surplus	①Stage surplus glass	b≦	Total defective point(B,C) 0.3mm	2	
	glass	②Surrounding surplus glass	Sho	uld not influence outline dime	nsion and as	sembling.



		Inspection item	Judgment standard			
			Category(application: B zone)			
7	Glass defect	①The front of lead terminals	A If $a \leq t$ and $b \leq 1.0$, c is not limited			
	crack		B $a \leq t, 1 \leq b \leq 2mm, c \leq 3mm$			
		b	C If glass crack cover alignment mark, $b \le 0.5$ mm.			
		w t a c	D Crack at two sids of lead terminals should not cover patterns and alignment mark			
		②Surrounding crack—non-contact side seal c h c h a t Inner border line of the seal Outer border line of the seal	b < Inner borderline of the seal			
		③ Surrounding crack— contact side seal c b a Inner border line of the seal Outer border line of the seal	b < Outer borderline of the seal			
		④Corner W A W C	A $a \le t$, $b \le 3.0$, $c \le 3.0$ *Glass crack should not cover patterns used for			



		Inspection item	Judgement standard
8	PCB defect	Component soldering: No cold soldering, short, open circuit, burr, tin ball The flat encapsulation component position deviation must be less than 1/2 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2)	Component $L \leq W/2$ W Soldering pad Lead $L_{2>0}$ Component $L_{1>0}$
		lead defect: The lead lack must be less than 1/2of its width; The lead burr must be less than 1/2 of the seam; Impurities connect with the near leads is not permitted	
		Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted	head Base Board Soldering tin is not permit in this area Soldering tin is not permit in this area Base Board



9. Precautions for Use of LCD Modules

9.1 Handling Precautions

- 9.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 9.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 9.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 9.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 9.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- -Aromatic solvents
- 9.1.6 Do not attempt to disassemble the LCD Module.
- 9.1.7 If the logic circuit power is off, do not apply the input signals.
- 9.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.

c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.



d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

9.2 Storage precautions

- 9.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 9.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature :0°C \sim 40°CRelatively humidity: $\leq 80\%$

- 9.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- **9.3** The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.